

## ESDA6V1W5

### *Transil array for data protection*

**Revision:B**

#### General Description

The ESDA6V1W5 is monolithic suppressor designed to protect components connected to data and transmission lines against ESD. This device clamps the voltage just above the logic level supply for positive transients and to a diode drop below ground for negative transients.

#### Applications

- Computers
- Printers
- Communication systems
- Cellular phones handsets and accessories
- Wireline and wireless telephone sets
- Set top boxes

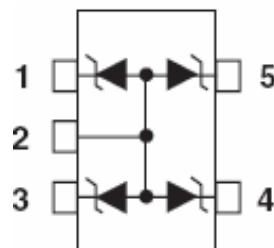
#### Features

- 4 Unidirectional Transil functions
- Low leakage current: < 1 µA
- Very small PCB area < 4.2 mm<sup>2</sup> typically
- High integration

#### Complies with the following standards

**IEC61000-4-2**
**Level 4 15 kV (air discharge)**
**8 kV(contact discharge)**
**MIL STD 883E - Method 3015-7 Class 3**
**25 kV HBM (Human Body Model)**

#### Functional diagram

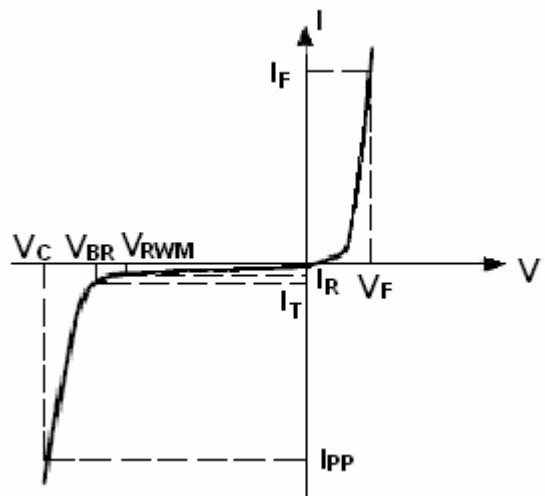

**SOT-353**

**ESDA6V1W5**

#### Absolute Ratings ( $T_{amb}=25^{\circ}C$ )

Symbol	Parameter	Value	Units
$P_{PP}$	Peak Pulse Power ( $t_p = 8/20\mu s$ )	150	W
$T_L$	Maximum lead temperature for soldering during 10s	260	°C
$T_{stg}$	Storage Temperature Range	-40 to +125	°C
$T_{op}$	Operating Temperature Range	-40 to +125	°C

## Electrical Parameter

Symbol	Parameter
$I_{PP}$	Maximum Reverse Peak Pulse Current
$V_C$	Clamping Voltage @ $I_{PP}$
$V_{RWM}$	Working Peak Reverse Voltage
$I_R$	Maximum Reverse Leakage Current @ $V_{RWM}$
$I_T$	Test Current
$V_{BR}$	Breakdown Voltage @ $I_T$
$I_F$	Forward Current
$V_F$	Forward Voltage @ $I_F$



## Electrical Characteristics

Part Numbers	$V_{BR}$			$I_T$	$V_{RWM}$	$I_R$	$V_F$	$I_F$	C
	Min.	Typ	Max.				Max.		Typ. 0v bias
	V	V	V				mA	V	mA
ESDA6V1W5	6.1	6.7	7.2	1	5	1	1.25	200	35

1.Square pulse  $I_{PP}=15A, t_p=2.5\mu s$     2. $V_{BR}=aT^*(T_{amb}-25^\circ C)*V_{BR}(25^\circ C)$

## Typical Characteristics

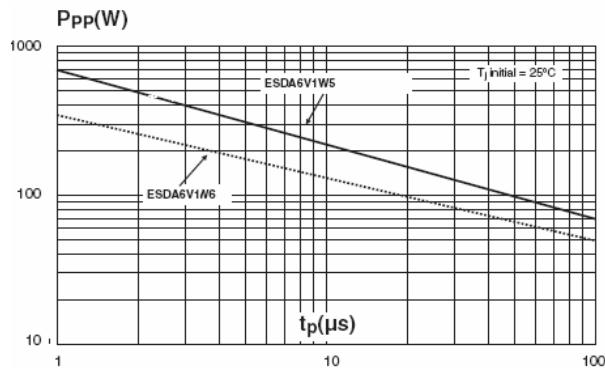


Fig1. Peak pulse power versus exponential Pulse duration ( $T_j \text{ initial}=25^\circ C$ )

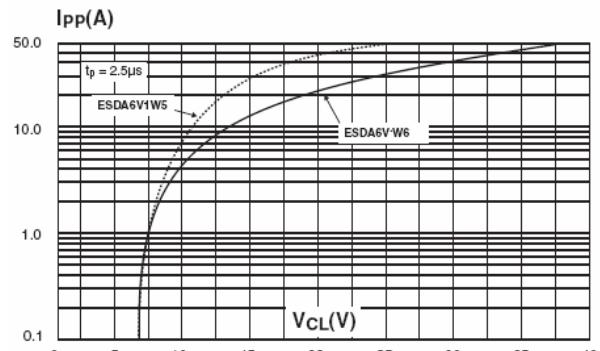
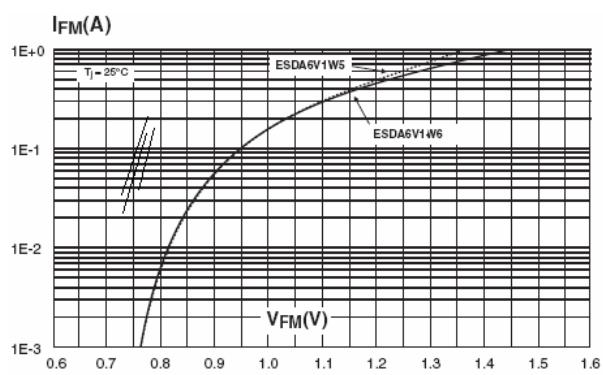
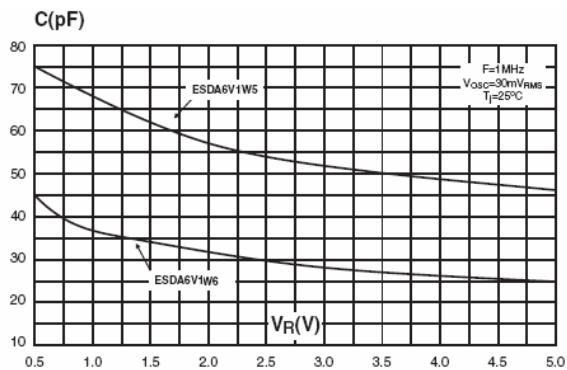


Fig2. Clamping voltage versus peak pulse current( $T_j \text{ initial}=25^\circ C$ , rectangular Waveform,  $t_p=2.5\mu s$ )

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**Fig 3 Capacitance Versus reverse applied voltage    Fig 4 Peak Forward Voltage Drop versus forward current**

## SOT-353 Mechanical Data

Diagram illustrating the SOT-353 mechanical dimensions. The top part shows the top view with lead spacing (E), lead thickness (e), lead height (b), and lead width (c). The bottom part shows the cross-sectional view with lead thickness (c), lead height (Q1), lead length (L), and chip height (HE). The right side is a detailed dimensions table.

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.8	1.1	0.031	0.043
A1	0	0.1	0	0.004
A2	0.8	1	0.031	0.039
b	0.15	0.3	0.006	0.012
c	0.1	0.18	0.004	0.007
D	1.8	2.2	0.071	0.086
E	1.15	1.35	0.045	0.053
e	0.65 Typ.		0.025 Typ.	
H	1.8	2.4	0.071	0.094
Q1	0.1	0.4	0.004	0.016

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